

1N5223B through 1N5258B

Silicon Epitaxial Planar Zener Diodes for Voltage Regulation

REJ03G1222-0300

(Previous: ADE-208-137B)

Rev.3.00

Aug 22, 2005

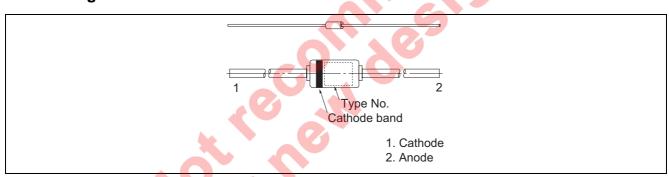
Features

- Glass package DO-35 structure ensures high reliability.
- Wide spectrum from 2.7 V through 36 V of zener voltage provide flexible application.

Ordering Information

Type No.	Cathode Band	Mark	Package Name	Package Code (Previous Code)
1N5223B through	Black	Type No.	DO-35	GRZZ0002ZB-A
1N5258B				(DO-35)

Pin Arrangement



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Power dissipation	Pd	500	mW
Surge power dissipation	Pd (surge) *1	10	W
Lead temperature	T _L * ²	230	°C
Junction temperature	Tj * ³	200	°C
Storage temperature	Tstg	-65 to +200	°C

Notes: 1. Non-recurrent square wave, pw = 8.3 ms, $Tj = 55^{\circ}C$, Tj is prior to surge.

- 2. Less than 1/16" from the case for 10 seconds.
- 3. By standard printed board, see fig 2.

Electrical Characteristics

 $(Ta = 25^{\circ}C)$

	Zener \	/oltage	Revers	e Current	Dynamic Resistance					
		Test		Test		Test		Test		
		Condition	I _R (μA)	Condition	$Z_{ZT}(\Omega)$	Condition	Z _{ZK} (Ω)	Condition	γ _Z (%/°C) * ¹	V _F *2 (V)
Type No.	V _z (V)	Iz (mA)	Max	V _R (V)	Max	I _{ZT} (mA)	Max	I _{ZK} (mA)	Max	Max
1N5223B	2.7 ± 5 (%)	20	75	1.0	30	20	1300	0.25	-0.08	1.1
1N5224B	2.8 ± 5 (%)	20	75	1.0	30	20	1400	0.25	-0.08	1.1
1N5225B	3.0 ± 5 (%)	20	50	1.0	29	20	1600	0.25	-0.075	1.1
1N5226B	3.3 ± 5 (%)	20	25	1.0	28	20	1600	0.25	-0.07	1.1
1N5227B	3.6 ± 5 (%)	20	15	1.0	24	20	1700	0.25	-0.065	1.1
1N5228B	3.9 ± 5 (%)	20	10	1.0	23	20	1900	0.25	-0.06	1.1
1N5229B	4.3 ± 5 (%)	20	5	1.0	22	20	2000	0.25	±0.055	1.1
1N5230B	4.7 ± 5 (%)	20	5	2.0	19	20	1900	0.25	±0.03	1.1
1N5231B	5.1 ± 5 (%)	20	5	2.0	17	20	1600	0.25	±0.03	1.1
1N5232B	5.6 ± 5 (%)	20	5	3.0	11	20	1600	0.25	+0.038	1.1
1N5233B	6.0 ± 5 (%)	20	5	3.5	7	20	1600	0.25	+0.038	1.1
1N5234B	6.2 ± 5 (%)	20	5	4.0	7	20	1000	0.25	+0.045	1.1
1N5235B	6.8 ± 5 (%)	20	3	5.0	5	20	750	0.25	+0.05	1.1
1N5236B	7.5 ± 5 (%)	20	3	6.0	6	20	500	0.25	+0.058	1.1
1N5237B	8.2 ± 5 (%)	20	3	6.5	8	20	500	0.25	+0.062	1.1
1N5238B	8.7 ± 5 (%)	20	3	6.5	8	20	600	0.25	+0.065	1.1
1N5239B	9.1 ± 5 (%)	20	3	7.5	10	20	600	0.25	+0.068	1.1
1N5240B	10 ± 5 (%)	20	3	8.0	17	20	600	0.25	+0.075	1.1
1N5241B	11 ± 5 (%)	20	2	8.4	22	20	600	0.25	+0.076	1.1
1N5242B	12 ± 5 (%)	20	1	9.1	30	20	600	0.25	+0.077	1.1
1N5243B	13 ± 5 (%)	9.5	0.5	9.9	13	9.5	600	0.25	+0.079	1.1
1N5244B	14 ± 5 (%)	9.0	0.1	10	15	9.0	600	0.25	+0.082	1.1
1N5245B	15 ± 5 (%)	8.5	0.1	11	16	8.5	600	0.25	+0.082	1.1
1N5246B	16 ± 5 (%)	7.8	0.1	12	17	7.8	600	0.25	+0.083	1.1
1N5247B	17 ± 5 (%)	7.4	0.1	13	19	7.4	600	0.25	+0.084	1.1
1N5248B	18 ± 5 (%)	7.0	0.1	14	21	7.0	600	0.25	+0.085	1.1
1N5249B	19 ± 5 (%)	6.6	0.1	14	23	6.6	600	0.25	+0.086	1.1
1N5250B	20 ± 5 (%)	6.2	0.1	15	25	6.2	600	0.25	+0.086	1.1

Notes: 1. 1N5223 to 1N5242: $I_Z = 7.5$ mA, 1N5243 to 1N5258: $I_Z = I_Z$, Ta = 25°C to 125°C

2. Tested with DC, $I_F = 200 \text{ mA}$

Electrical Characteristics (cont.)

 $(Ta = 25^{\circ}C)$

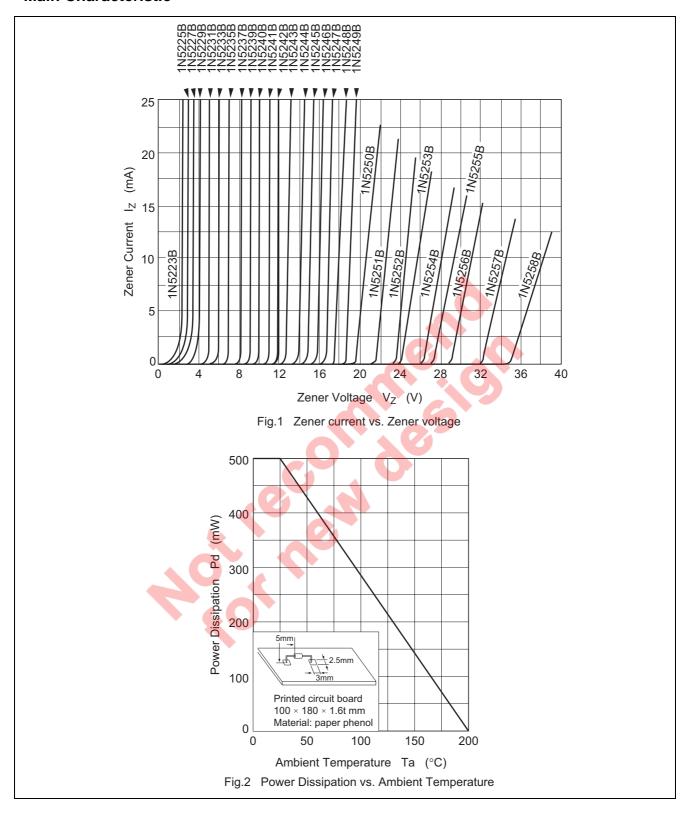
	Zener Voltage Re		Revers	Reverse Current		Dynamic Resistance				
		Test		Test		Test		Test		
		Condition	I _R (μA)	Condition	Z _{ZT} (Ω)	Condition	Z _{ZK} (Ω)	Condition	γ _Z (%/°C) * ¹	V _F *2 (V)
Type No.	V _z (V)	Iz (mA)	Max	V _R (V)	Max	I _{ZT} (mA)	Max	I _{zK} (mA)	Max	Max
1N5251B	22 ± 5 (%)	5.6	0.1	17	29	5.6	600	0.25	+0.087	1.1
1N5252B	24 ± 5 (%)	5.2	0.1	18	33	5.2	600	0.25	+0.088	1.1
1N5253B	25 ± 5 (%)	5.0	0.1	19	35	5.0	600	0.25	+0.089	1.1
1N5254B	27 ± 5 (%)	4.6	0.1	21	41	4.6	600	0.25	+0.090	1.1
1N5255B	28 ± 5 (%)	4.5	0.1	21	44	4.5	600	0.25	+0.091	1.1
1N5256B	30 ± 5 (%)	4.2	0.1	23	49	4.2	600	0.25	+0.091	1.1
1N5257B	33 ± 5 (%)	3.8	0.1	25	58	3.8	700	0.25	+0.092	1.1
1N5258B	36 ± 5 (%)	3.4	0.1	27	70	3.4	700	0.25	+0.093	1.1

Notes: 1. 1N5223 to 1N5242: $I_Z = 7.5$ mA, 1N5243 to 1N5258: $I_Z = I_Z$, Ta = 25°C to 125°C

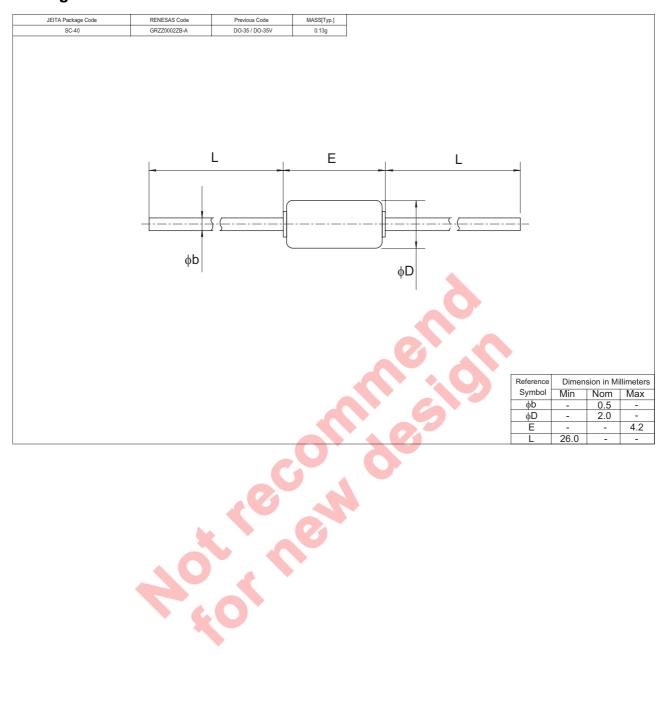
2. Tested with DC, $I_F = 200 \text{ mA}$



Main Characteristic



Package Dimensions



Renesas Technology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Keep safety first in your circuit designs!

1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal righty, fire or property damage.

Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

Notes regarding these materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.

2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.

3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.

The information described here may contain technical inaccuracies or typographical errors.

Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.

Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (http://www.renesas.com).

home page (http://www.renesas.com).

4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.

5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.

6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.

7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.

Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.

8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.

Refer to "http://www.renesas.com/en/network" for the latest and detailed information.

RENESAS SALES OFFICES

Renesas Technology America, Inc. 450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology Hong Kong Ltd.

7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd. 10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd. Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd.

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd.Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> 2-796-3115, Fax: <82> 2-796-2145

Renesas Technology Malaysia Sdn. Bhd.

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510

© 2005. Renesas Technolog	y Corp., All rights reserved.	Printed in Japan.

http://www.renesas.com

Colophon .3.0